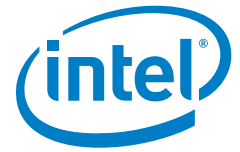


PRODUCT BRIEF

Intel® Solid State Drive Data Center Family for PCIe®



Consistently Amazing

Make the Switch to Faster Data

Deliver breakthrough performance with Intel PCIe Solid State Drives.



Servers can now support more users simultaneously, compute on larger data sets, and address high-performance computing at lower Total Cost of Ownership (TCO).¹

Intel® SSD Data Center Tool provides a powerful set of management capabilities.

Intel led the industry in creation of a new Non-Volatile Memory Express (NVMe™) storage interface standard.*

Intel is driving transition to NVMe SSDs by providing a comprehensive product line.

For more information, visit www.intel.com/design/flash/nand/managesd.htm

Breakthrough Performance¹

The Intel® Solid State Drive (SSD) Data Center Family for PCIe brings extreme data throughput directly to Intel® Xeon® processors with up to six times faster data transfer speed than 6 Gbps SAS/SATA SSDs. The Intel SSD Data Center Family for PCIe is capable of reading data up to 2.8GB/s and 460k Input/Output Operations Per Second (IOPS) and writing up to 2.0GB/s and 175k IOPS.

The performance of a single drive from the Intel SSD Data Center Family for PCIe, specifically the Intel® SSD DC P3700 Series (460K IOPS), can replace the performance of 7 SATA SSDs aggregated through an HBA (~500K IOPS). At 200 IOPS per Hard Disk Drive (HDD), 2,300 15K HDDs would be needed to match the performance of one Intel SSD Data Center Family for PCIe device.

Intel SSD Data Center Family for PCIe's consistently amazing performance provides fast, unwavering data streams directly to Intel Xeon processors making server data transfers efficient. SSD performance consistency provides scalable throughput when multiple SSDs are unified into a single storage volume. The massive storage bandwidth increase feeds Intel Xeon processor systems giving data center servers a performance boost.

Proven Quality and Reliability

Intel SSD Data Center Family for PCIe devices are based on Intel-developed controller, firmware, and leading manufacturing process NAND flash memory. Rigorous qualification and compatibility testing ensures a highly reliable SSD. By combining SSD NAND management techniques and NAND silicon enhancements, High Endurance Technology

(HET) enables the Intel DC P3700 Series to achieve 17 drive writes per day over a five year drive life.

Modernize Data Center Storage

NVMe is engineered for current and future Non-Volatile Memory (NVM) technologies, unlike SAS/SATA SSDs. NVMe overcomes SAS/SATA SSD performance limitations by optimizing hardware and software to take full advantage of NVM SSD technology. Intel Xeon processors efficiently transfer data in fewer clock cycles with the NVMe optimized software stack compared to the legacy Advance Host Controller Interface (AHCI) stack, reducing latency and overhead. Direct CPU connection also eliminates Host-Bus-Adapter (HBA) cards, further reducing latency and TCO.

Comprehensive Solution

Intel's product line enables extensive system compatibility, completes numerous industry standard compliance certifications, and delivers Intel drivers, supporting industry driver development. The Intel SSD Data Center Family for PCIe includes the Intel Solid State Drive DC P3700, P3600, and P3500 Series providing a full range of endurance up to 17 full-capacity writes per day, capacity up to 2TB, and 2.5-inch and Add-in-Card (AIC) form factors. Intel-enabled NVMe software drivers are provided by major operating system vendors including Microsoft® Server 2012 and 2008, Windows® 7, 8, and 8.1 Red Hat® 7.0/6.6/6.5, SLES® 11 SP3, UEFI® 2.3.1, and the Linux® Open Source development community. The new 2.5-inch form factor with hot-swap capability provides convenient front panel serviceability allowing quick, uninterrupted installation. The AIC form factor conveniently fits in half-height, half-length (HHHL) slots.

TECHNICAL SPECIFICATIONS¹

| PRODUCT FAMILY | | INTEL® SOLID STATE DRIVE DATA CENTER FAMILY FOR PCIe® | | |
|---|------------|--|--|----------------------------|
| SERIES NAME | | INTEL® SSD DC P3500 SERIES | INTEL® SSD DC P3600 SERIES | INTEL® SSD DC P3700 SERIES |
| Capacities | | 400GB, 1.2TB, 2TB | 400GB, 800GB, 1.2TB, 1.6TB, 2TB | 400GB, 800GB, 1.6TB, 2TB |
| Sequential | Read | Up to 2500 | Up to 2600 | Up to 2800 |
| Sustained | Write | Up to 1700 | Up to 1700 | Up to 2000 |
| Performance ^{2,3} (MB/s) | | | | |
| Random I/O | Read | Up to 450 | Up to 450 | Up to 460 |
| Operations | Write | Up to 35 | Up to 56 | Up to 175 |
| | | Up to 85 | Up to 160 | Up to 265 |
| 70/30 Read/Write per Second 4KB K-IOPS ^{2,3} | | | | |
| Lifetime Endurance ⁴ | Up to: | 0.3 Drive Writes Per Day | 3 Drive Writes Per Day | 17 Drive Writes Per Day |
| Latency ⁵ | Read/Write | 20µs / 20µs | | |
| Interface | | Non-Volatile Memory express (NVMe™) PCIe 3.0 x4 | | |
| Form Factor | | 2.5-inch | AIC | |
| Height / Weight | | 15mm/up to 125 grams | Half-Height Half-Length (HHHL)/195 grams | |
| Life Expectancy | | 2 million hours Mean Time Between Failures (MTBF), 230 years | | |
| Power Consumption ⁶ | | Active: <25W (Write) / <11W (Read) | | Idle: 4W Typical |
| NAND Flash Memory | | Intel® NAND Flash Memory Multi-Level Cell (MLC) 20nm | | |
| Operating Temperature ⁷ | | 2.5-inch FF: 0° C to 35° C ambient temperature with suggested airflow, 0° to 70° C case temperature AIC: 0° C to 55° C ambient temperature with suggested airflow | | |
| RoHS Compliance | | Meets the requirements of European Union (EU) RoHS Compliance Directives | | |
| Software Support | | Intel® Solid State Drive Data Center Tool, NVMe Drivers: www.intel.com | | |
| Product Ordering | | Solid State Drive Computing Starts with Intel Inside®. To order visit www.intel.com/ssd | | |



Solid State Drive Computing Starts with Intel Inside®. For more information, visit www.intel.com/ssd

¹ Based on the Intel® Solid State Drive DC P3500, P3600 and P3700 Series Product Specifications. Random I/O Operations based on Thousand (K) IOPS

² Performance varies by capacity and is measured using IOMeter* with Queue Depth 128, for sequential workload Queue Depth 128 with single worker. For Random workload Queue Depth 32, with 4 workers.

³ Measurements are performed on full span of logical block address (LBA) range on an SSD that is filled to capacity with data. IOPS setup: Intel® Core™ i7-3770K CPU @ 3.50GHz, 8GB of system memory, Windows® Server 2012, and IOMeter tool were used. DC P3700 system performance is configuration dependent. Random performance is collected with 4 workers each with 32 QD.

⁴ Using JESD218 standard with JESD219 workload, Terabytes Written (TBW)

⁵ Average latency measured with 4KB sequential I/O at Queue Depth¹

⁶ Active power measured during execution of Full Sequential Workload with 128KB transfer size, idle power is measured when there is no I/O to SSD.

⁷ For suggested airflow please refer to the product specification document.

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| <u>SSDPE2ME020T401</u> | <u>SSDPEDMD020T401</u> | <u>SSDPEDME800G401</u> | <u>SSDPE2ME016T401</u> | <u>SSDPEDMD016T401</u> |
| <u>SSDPEDME012T401</u> | <u>SSDPE2ME800G401</u> | <u>SSDPEDME016T401</u> | <u>SSDPE2MD800G401</u> | <u>SSDPE2MD016T401</u> |
| <u>SSDPE2ME012T401</u> | <u>SSDPE2ME400G401</u> | <u>SSDPEDMD800G401</u> | | |